

HSMF-C113/C114/C115/C118/C128 Miniature Right-Angle Tricolor Surface-Mount ChipLEDs

Description

Broadcom tests parts at the absolute maximum rated conditions recommended for the device. The actual performance that you obtain from Broadcom[®] parts depends on the electrical and environmental characteristics of your application, but will probably be better than the performance outlined in the table.

Table 1: Reliability Tests

Test Name	Reference	Test Conditions	Units Tested	Units Failed
High Temperature Operating Life	JESD22-A108	$T_A = 55^{\circ}C$, $I_F = 9$ mA for 500 hours (all chips on)	56	0
Low Temperature Operating Life	JESD22-A108	$T_A = -40^{\circ}C$, $I_F = 15$ mA for 500 hours (all chips on)	56	0
Temperature Humidity Operating Life	JEITA ED-4701/ 100 102	$T_A = 60^{\circ}C$, 90% RH, $I_F = 6$ mA for 500 hours (all chips on)	56	0
Temperature Cycle	JESD22-A104	-40°C/85°C, 15-minute dwell, 5-minute transfer, 100 cycles	336	0
High Temperature Storage Life	JESD22-A103	T _A = 85°C for 500 hours	56	0
Low Temperature Storage	JESD22-A119	$T_A = -40^{\circ}C$ for 500 hours	56	0
Temperature Humidity Storage Life	JEITA ED-4701/ 100 103	T _A = 60°C, 90% RH for 500 hours	56	0
Mechanical Shock	JESD22-B104	5 shocks each X1, X2, Y1, Y2, Z1, Z2, 1500G, 0.5-ms pulse	28	0
Vibration	JESD22-B103	4 cycles, 4 minutes each X, Y, and Z at 0.06 in. at 20 Hz to 2000 Hz, peak acceleration 20G	28	0
Solderability	J-STD-002	245°C for 5 seconds	28	0

NOTE: A failure is any LED that is open or shorted or that failed to emit light (except for the Solderability test).

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